EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	10/575511	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:01
S2	20576	EP-A -0626714-$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:03
S3	0	EP-0626714-$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:04
S4	0	EP-0626714.ap,prai.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:05
S5	0	EP0626714.ap,prai.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:06
S6	0	EP-626714-4.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:07
S7	2	EP-626714-$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:27
S8	2	"2003142453".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:29
S9	2	"20030142453".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:36

S10	2	"5977860".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:37
S11	2	"5699032".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:39
S12	2	"20030048620".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 13:47
S13	8	(electronic near ballast) same (gas near discharge near lamp) same (PB or PCB or PWB or (printed near board$2) or (circuit near board $2) or (wiring near board$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/13 17:33
S14	943	361/777.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/14 07:31
S15	328	337/297.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/14 07:45
S16	957	361/777.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/19 08:03
S17	2203	361/760.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/19 08:26

S18	0	(print$2 and circuit and board and substrate and plurality and electronic and component and pattern and metal and track and connect$3 and cover$2 and protective and non adj conductive and layer and fuse and narrow$2 and uncover$2 and expos$2 and air and slot and alongside and entire and length and sides and located and distance and less and S17 adj mm).clm.	US-PGPUB	OR	ON	2008/05/19 09:22
S19	1	(print$2 and circuit and board and substrate and plurality and electronic and component and pattern and metal and track and connect$3 and cover$2 and protective and non adj conductive and layer and fuse and narrow$2 and uncover$2 and expos$2 and air).clm.	US-PGPUB	OR	ON	2008/05/19 09:26
S20	879209	"174"/$.ccls. or "361"/ $.ccls. or "257"/$.ccls. or "29"/$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 09:48
S21	24814	S20 and (fuse or antifuse or (change near board) or (universal near board) or (reconfiguration near board) or (consumer near board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 09:53
S22	2	S21 and (fuse or antifuse) same ((change near board) or (universal near board)or (reconfiguration near board) or (consumer near board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 09:54

S23	24560	S21 and (fuse or antifuse)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 09:55
S24	266	S21 and ((change near board) or (universal near board)or (reconfiguration near board) or (consumer near board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 09:56
S25	4534	174/261,260.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 10:16
S26	190	S25 and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 10:16
S27	2409	174/261.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 10:17
S28	2764	174/260.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 10:47
S29	402285	"361"/$.ccls. or "29"/$. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 13:13
S30	13348	S29 and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 13:14
S31	0	361/777.clas. and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 13:15
S32	37	361/777.ccls. and fuse	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/21 13:15

5/23/2008 8:55:52 AM
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